

GH30507T2A

(Under development)

■ Features

- (1) Monolithic dual-wavelength laser diode
- (2) Employing a self-pulsation laser chip enables a compact and low cost pick-up.
It eliminates the need for radio frequency modulation circuit and related resistors/shields.
- (3) Wavelength (MAX.) : TYP. 788nm/654nm
- (4) Optical power output (MAX.) : 7mW/5mW (CW)
- (5) High emitting point accuracy by monolithic structure ($110\pm 3\mu\text{m}$)
- (6) Operating temperature : MAX. 70°C
- (7) $\phi 5.6\text{mm}$ package (4 - lead)

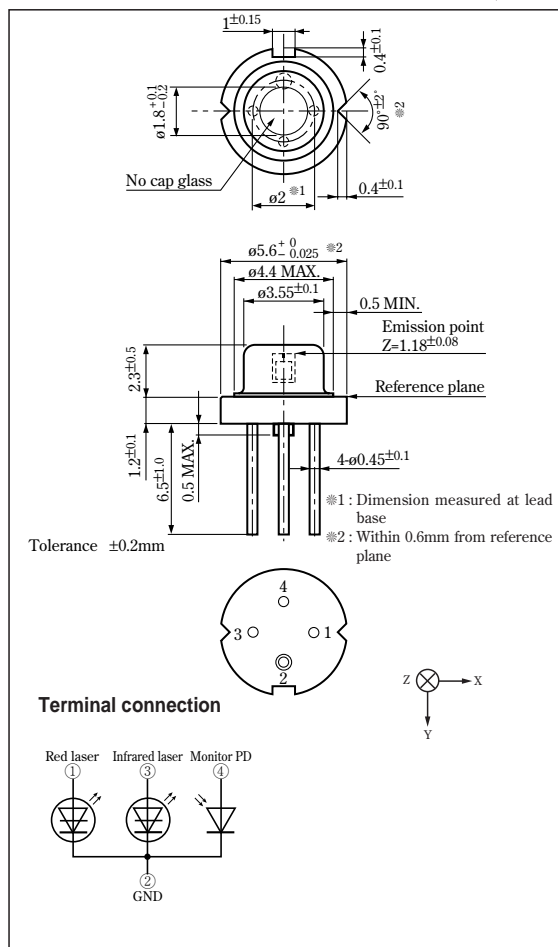
■ Applications

- (1) DVD-ROM drives
- (2) DVD video players

Self-pulsation Type Dual-wavelength Laser Diode for DVD-ROM/DVD Video(654nm-5mW, 788nm-7mW)

■ Outline Dimensions

(Unit : mm)



■ Absolute Maximum Ratings

($T_c=25^\circ\text{C}$ *1)

Parameter	Symbol	Rating		Unit
		Red laser	Infrared laser	
*3 Optical power output	P_O	5	7	mW
Reverse voltage	Laser V_{rl}	2		V
	Monitor photodiode V_{rd}	30		V
*1 Operating temperature	$T_{op(c)}$	-10 to +70		°C
*1 Storage temperature	T_{stg}	-40 to +85		°C
*2 Soldering temperature	T_{slid}	300		°C

*1 Case temperature

*2 At the position of 1.6mm or more from the lead base (Within 3s)

*3 CW (Continuous Wave) drive

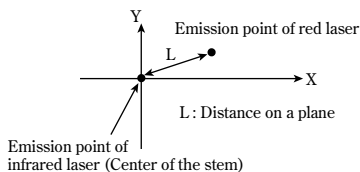
SHARP

Distance between Laser Emission Points and Emission Point Accuracy

Distance between laser emission points

Unit : μm

	MIN.	TYP.	MAX.
L	107	110	113



Emission point accuracy

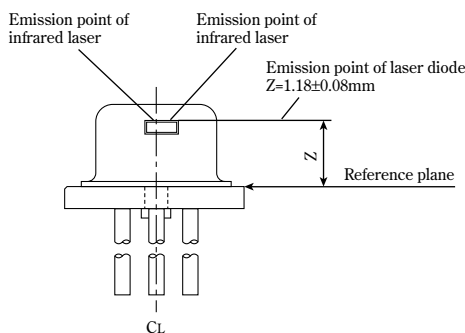
Unit : μm

X ^{#1}	0 \pm 80
Y ^{#2}	0 \pm 80
Z ^{#3}	1.18 \pm 80

^{#1} Emission point position of infrared laser to the stem center(X direction)

^{#2} Emission point position of infrared laser to the stem center(Y direction)

^{#3} Emission point position of laser to the reference plane (Z)



Electro-optical Characteristics^{#1}

(T_c=25°C)

Parameter	Symbol	Red laser				Infrared laser				Unit	
		Conditions	MIN.	TYP.	MAX.	Conditions	MIN.	TYP.	MAX.		
Threshold current	I _{th}	-	-	45	-	-	-	34	-	mA	
Operating current	I _{op}	P _o =5mW	-	55	-	P _o =5mW	-	44	-	mA	
Operating voltage	V _{op}		-	2.2	2.5		-	1.9	-	V	
Wavelength	λ_p		-	654	-		-	788	-	nm	
Half intensity angle	^{#2#3} Parallel		$\theta_{//}$	-	8.5		-	-	14	-	°
	^{#2#3} Perpendicular		θ_{\perp}	-	35		-	-	38	-	°
Misalignment angle	^{#3} Parallel		$\Delta\theta_{//}$	-1.5	0		+1.5	-1.5	0	+1.5	°
	^{#3} Perpendicular	$\Delta\theta_{\perp}$	-2	0	+2	-3	0	+3	°		
Differential efficiency	η_d	$\frac{3\text{mW}}{I(5\text{mW})-I(2\text{mW})}$	-	0.5	-	$\frac{3\text{mW}}{I(5\text{mW})-I(2\text{mW})}$	-	0.55	-	mW/mA	
Interference pattern intensity	α	P _o =5mW	-	-	0.9	P _o =5mW	-	-	0.99	-	

^{#1} Initial value, CW (Continuous Wave) drive

^{#3} Parallel to the junction plane (X-Z plane), Perpendicular to the junction plane (Y-Z plane)

^{#2} Angle at 50% peak intensity (full-width at half-maximum)

^{#4} R= $\Delta P/P$ ΔP : the maximum deviation of the far field pattern from its approximate curve P : the peak of the approximate curve

Electrical Characteristics of Photodiode

(T_c=25°C)

Parameter	Symbol	Red laser				Infrared laser				Unit
		Conditions	MIN.	TYP.	MAX.	Conditions	MIN.	TYP.	MAX.	
Dark current	I _d	V _{rd} =5V	-	-	150	V _{rd} =5V	-	-	150	nA

• Please refer to the chapter "Handling Precautions"

NOTICE

- The circuit application examples in this publication are provided to explain representative applications of SHARP devices and are not intended to guarantee any circuit design or license any intellectual property rights. SHARP takes no responsibility for any problems related to any intellectual property right of a third party resulting from the use of SHARP's devices.
- Contact SHARP in order to obtain the latest device specification sheets before using any SHARP device. SHARP reserves the right to make changes in the specifications, characteristics, data, materials, structure, and other contents described herein at any time without notice in order to improve design or reliability. Manufacturing locations are also subject to change without notice.
- Observe the following points when using any devices in this publication. SHARP takes no responsibility for damage caused by improper use of the devices which does not meet the conditions and absolute maximum ratings to be used specified in the relevant specification sheet nor meet the following conditions:
 - (i) The devices in this publication are designed for use in general electronic equipment designs such as:
 - Personal computers
 - Office automation equipment
 - Telecommunication equipment [terminal]
 - Test and measurement equipment
 - Industrial control
 - Audio visual equipment
 - Consumer electronics
 - (ii) Measures such as fail-safe function and redundant design should be taken to ensure reliability and safety when SHARP devices are used for or in connection with equipment that requires higher reliability such as:
 - Transportation control and safety equipment (i.e., aircraft, trains, automobiles, etc.)
 - Traffic signals
 - Gas leakage sensor breakers
 - Alarm equipment
 - Various safety devices, etc.
 - (iii) SHARP devices shall not be used for or in connection with equipment that requires an extremely high level of reliability and safety such as:
 - Space applications
 - Telecommunication equipment [trunk lines]
 - Nuclear power control equipment
 - Medical and other life support equipment (e.g., scuba).
- Contact a SHARP representative in advance when intending to use SHARP devices for any "specific" applications other than those recommended by SHARP or when it is unclear which category mentioned above controls the intended use.
- If the SHARP devices listed in this publication fall within the scope of strategic products described in the Foreign Exchange and Foreign Trade Law of Japan, it is necessary to obtain approval to export such SHARP devices.
- This publication is the proprietary product of SHARP and is copyrighted, with all rights reserved. Under the copyright laws, no part of this publication may be reproduced or transmitted in any form or by any means, electronic or mechanical, for any purpose, in whole or in part, without the express written permission of SHARP. Express written permission is also required before any use of this publication may be made by a third party.
- Contact and consult with a SHARP representative if there are any questions about the contents of this publication.